

NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
TERMINALS: PHOSPHOR BRONZE, .012/ 0.30 THICK
SHIELD: BRASS, .007/ 0.18 THICK

2) FINISH:

TERMINALS:

- A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS AND/OR SHIELD.

SHIELD:

100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES / 1.27
MICROMETERS COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43202.

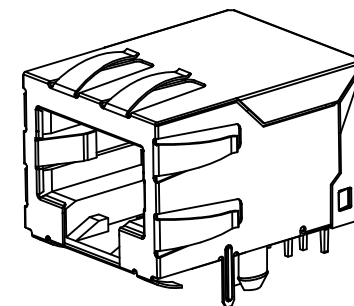
4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-003.
UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
PER MOLEX PACKAGING SPECIFICATION PK-43202-005.
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-004.

5) SEE SHEETS 7 - 9 FOR P.C. BOARD LAYOUTS.

6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.

7) THIS PART CONFROMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



SHIELDED MODULAR JACK
SHOWN WITH PANEL GROUND
OPTION 'D' AND FRONT
PCB GROUND TABS.

DRAWING LEGEND

SHEET 1-	NOTES; DRAWING LEGEND
SHEET 2-	SHIELDED MODULAR JACK W/ BOTTOM GROUND TABS
SHEET 3-	SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS
SHEET 4-	UNSHIELDED MODULAR JACK
SHEET 5-	PART NUMBER CHARTS
SHEET 6-	PART NUMBER CHARTS
SHEET 7-	FOOTPRINT LAYOUT FOR 4 POSITION HOUSING
SHEET 8-	FOOTPRINT LAYOUT FOR 6 POSITION HOUSING
SHEET 9-	FOOTPRINT LAYOUT FOR 8 POSITION HOUSING

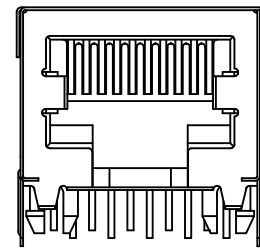
ADD VIEWS EC NO: UCP2012-2472 DRWN: NGUYEN CHKD: J.BELL APPR: F.S.MITH 2012/02/03 2012/02/03 2012/02/09	DESCRIPTION L5	REV	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
						IN/MM		4:1	INCH		
						DRAWN BY DATE		TITLE			
						CHECKED BY DATE		ULTRA LOW PROFILE			
						APPROVED BY DATE		RIGHT ANGLE MODULAR JACK			
				MATERIAL NO.		DOCUMENT NO.		SHEET NO.			
				SEE SHTS 5&6		SDA-43202		1 OF 9			
				SIZE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

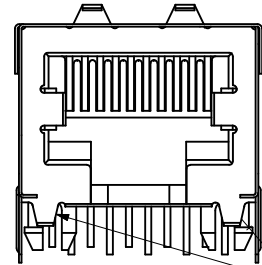
SHIELDED MODULAR JACK W/BOTTOM GROUND TABS

SIZE 8 LOADED 10 VERSION SHOWN

SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



OPTION "A"
NO TOP OR SIDE TABS

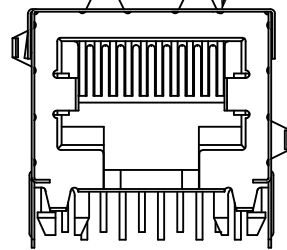


OPTION "B"
TOP TABS

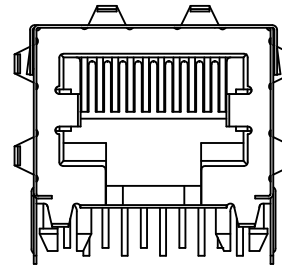
BOTTOM
GROUND TABS

OPTIONAL TOP GROUND TABS

SHIELDED MODULAR JACK ASSEMBLY
SEE SHEET 5 FOR MATERIAL NO.

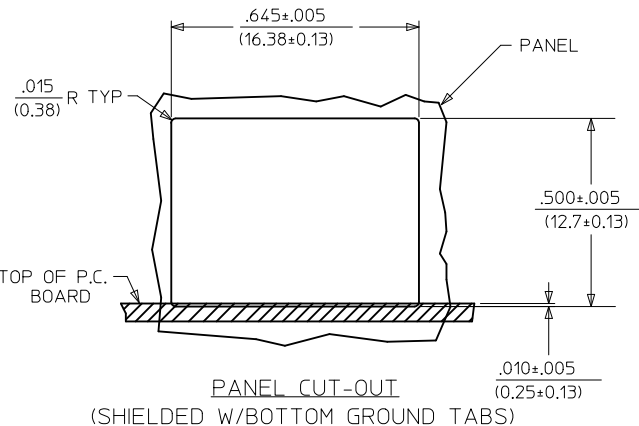


OPTION "C"
TOP AND STAGGERED SIDE TABS

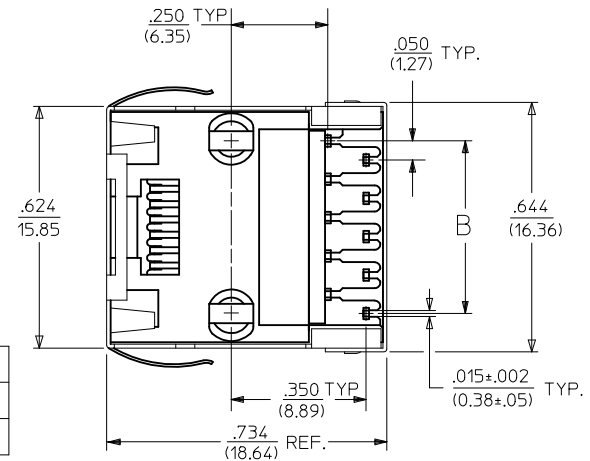
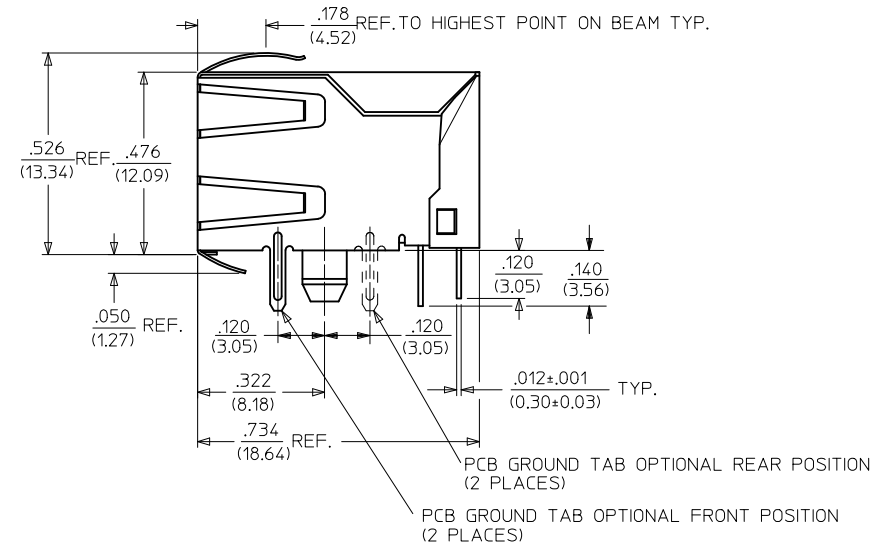


OPTION "D"
TOP AND SIDE TABS

OPTIONAL SIDE
GROUND TABS
(2 PLACES)



HOUSING SIZE	CIRCUIT SIZE	B
8	10	.450±.005 11.43±.13
8	8	.350±.005 8.89±.13

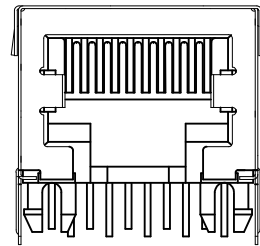


SEE SHEET 1	EC NO: UCP2012-2472 DRAWN: NGUYEN CHKD: JELL APPR: FSMITH	2012/02/03 2012/02/03 2012/02/09	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION		
				 =0  =0  =0			DRAWN BY JTR	DATE 1993/03/31	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY				
							CHECKED BY JTR	DATE 1993/03/31					
					4 PLACES ± ---	± ---		APPROVED BY FSMITH	DATE 2012/02/09	molex MOLEX INCORPORATED			
					3 PLACES ± ---	± .010		MATERIAL NO.	DOCUMENT NO.				
					2 PLACES ± 0.25	± .014		SEE SHEET 5					
				1 PLACE ± 0.36	± ---		SDA-43202						
ANGULAR ±1/2°													
REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									

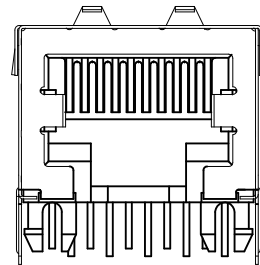
SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS

SIZE 8, LOADED 10 VERSION SHOWN

SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



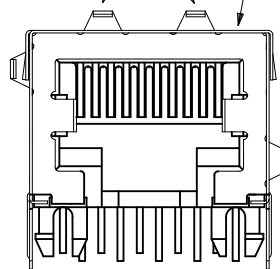
OPTION "E"
NO TOP OR SIDE TABS



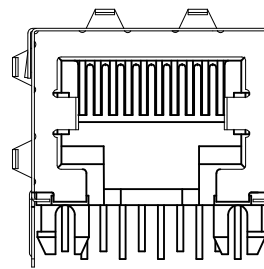
OPTION "F"
TOP TABS

OPTIONAL TOP GROUND TABS

SHIELDED MODULAR JACK ASSEMBLY
SEE SHEET 6 FOR MATERIAL NO.

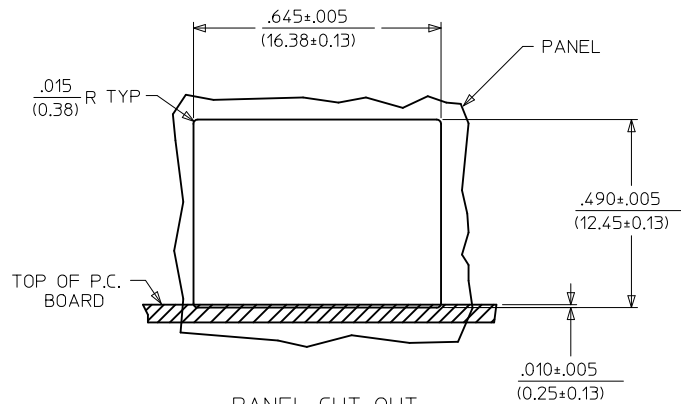


OPTION "G"
TOP AND STAGGERED SIDE TABS



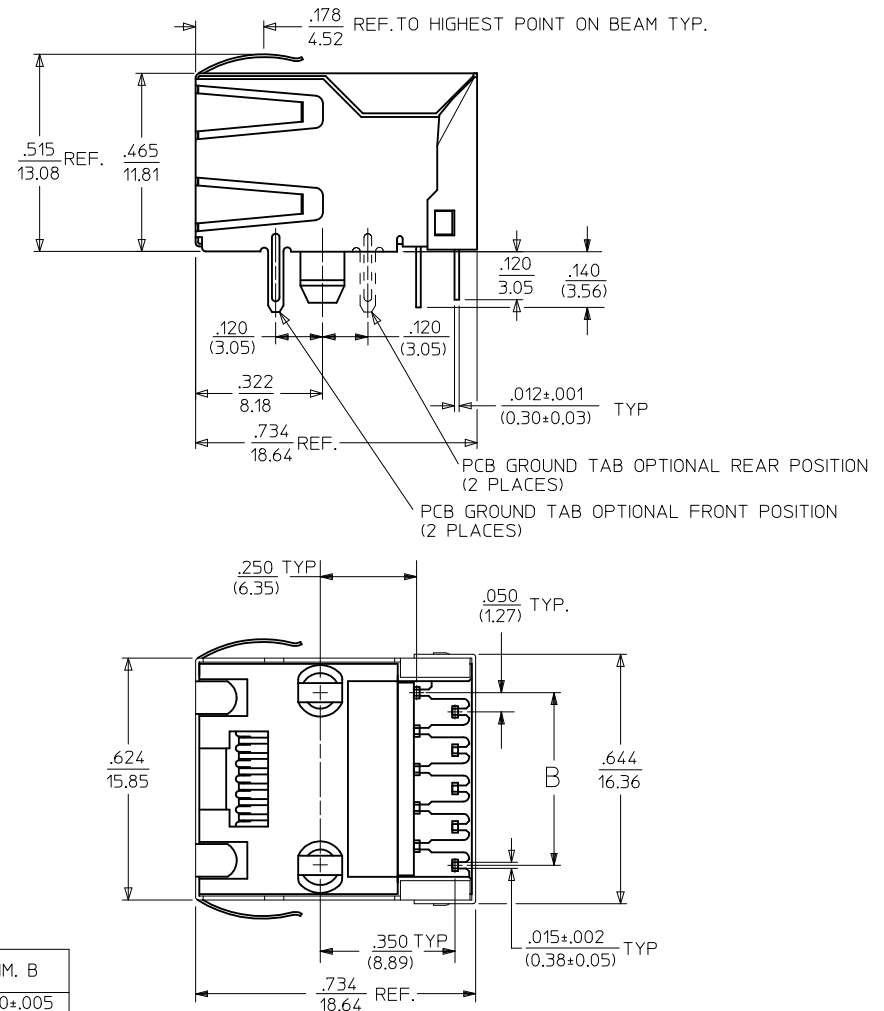
OPTION "H"
TOP AND SIDE TABS

OPTIONAL SIDE
GROUND TABS
(2 PLACES)

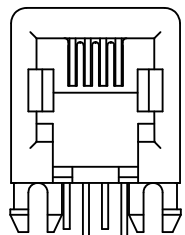


PANEL CUT-OUT
(SHIELDED W/O BOTTOM GROUND TABS)

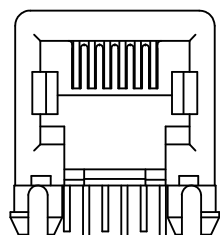
HOUSING SIZE	CIRCUIT SIZE	DIM. B
8	10	.450±.005 (11.43±0.13)
8	8	.350±.005 (8.89±0.13)



SEE SHEET 1 EC NO: UCP2012-2472 DRAWN: NGUYEN 2012/02/03 CHKD: J.BELL 2012/02/09 APPR: FSMITH	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION			
						DRAWN BY JTR	DATE 1993/03/31	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY					
						CHECKED BY JTR	DATE 1993/03/31	MOLEX INCORPORATED					
						APPROVED BY FSMITH	DATE 2012/02/09						
						MATERIAL NO.		DOCUMENT NO.			SHEET NO. 3 OF 9		
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE SHEET 6		SDA-43202					
						SIZE C	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



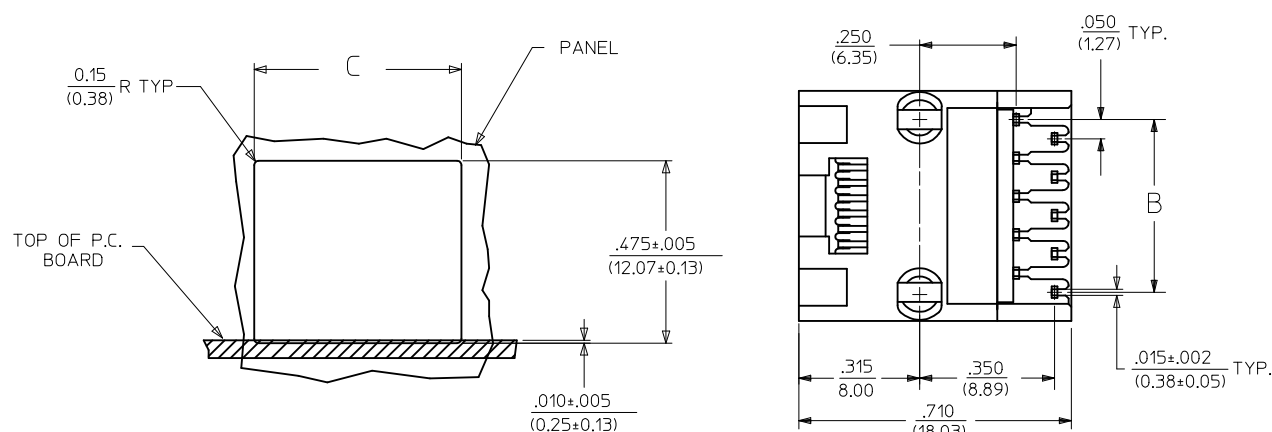
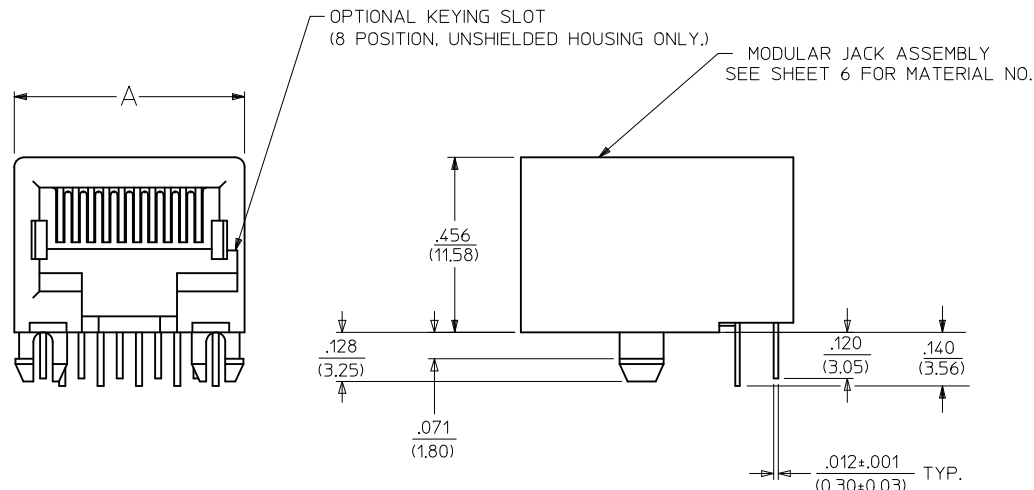
SIZE 4
LOADED 4 SHOWN



SIZE 6
LOADED 6 SHOWN

UNSHIELDED MODULAR JACKS

SIZE 8, LOADED 10 SHOWN



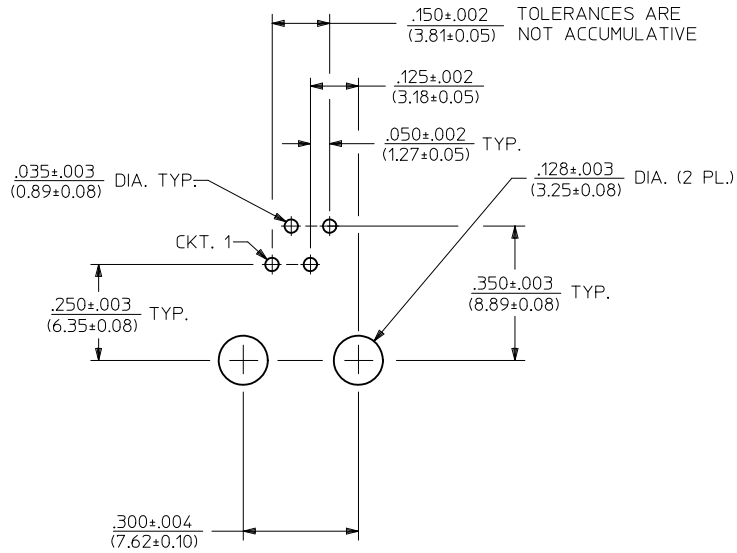
PANEL CUT-OUT (UNSHIELDED)

HOUSING SIZE	LOADED CIRCUITS	A	B	C
4	4	.440 (11.18)	.150±.005 (3.81±0.13)	.460±.005 (11.68±0.13)
4	2	.440 (11.18)	.050±.005 (1.27±0.13)	.460±.005 (11.68±0.13)
6	6	.520 (13.21)	.250±.005 (6.35±0.13)	.540±.005 (13.72±0.13)
6	4	.520 (13.21)	.150±.005 (3.81±0.13)	.540±.005 (13.72±0.13)
6	2	.520 (13.21)	.050±.005 (1.27±0.13)	.540±.005 (13.72±0.13)
8	10	.600 (15.24)	.450±.005 (11.43±0.13)	.620±.005 (15.75±0.13)
8	8	.600 (15.24)	.350±.005 (8.89±0.13)	.620±.005 (15.75±0.13)
8	6	.600 (15.24)	.250±.005 (6.35±0.13)	.620±.005 (15.75±0.13)
8	4	.600 (15.24)	.150±.005 (3.81±0.13)	.620±.005 (15.75±0.13)
8	2	.600 (15.24)	.050±.005 (1.27±0.13)	.620±.005 (15.75±0.13)

SEE SHEET 1 EC NO: UCP2012-2472 DRAWN: NGUYEN CHKD: J.BELL APPR: FSM/TH REV	DESCRIPTION 2012/02/03 2012/02/03 2012/02/09	QUALITY SYMBOLS <
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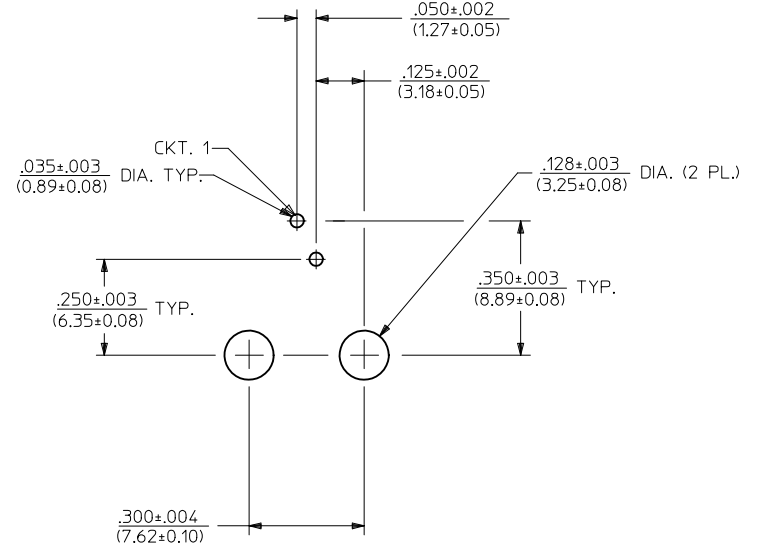
	13	12	11	10	9	8	7	6	5	4	3	2	1					
J	SHIELDED MODULAR JACKS W/BOTTOM GROUND TABS (SHEET 2)														J			
	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION	TERMINAL PLATING OPTION	PACKAGING OPTION	HOUSING COLOR										
I	43202-8900	8	10	A	FRONT POSITION	A	TRAY	BLACK							I			
	43202-8901	8	10	B	FRONT POSITION	A	TRAY											
	43202-8902	8	10	C	FRONT POSITION	A	TRAY											
	43202-8903	8	10	D	FRONT POSITION	A	TRAY											
H	43202-8908	8	10	A	REAR POSITION	A	TRAY		BLACK							H		
	43202-8909	8	10	B	REAR POSITION	A	TRAY											
	43202-8910	8	10	C	REAR POSITION	A	TRAY											
	43202-8911	8	10	D	REAR POSITION	A	TRAY											
G	43202-8916	8	8	A	FRONT POSITION	A	TRAY			BLACK							G	
	43202-8917	8	8	B	FRONT POSITION	A	TRAY											
	43202-8918	8	8	C	FRONT POSITION	A	TRAY											
	43202-8919	8	8	D	FRONT POSITION	A	TRAY											
F	43202-8924	8	8	A	REAR POSITION	A	TRAY				BLACK							F
	43202-8925	8	8	B	REAR POSITION	A	TRAY											
	43202-8926	8	8	C	REAR POSITION	A	TRAY											
	43202-8927	8	8	D	REAR POSITION	A	TRAY											
E														E				
D														D				
C														C				
B														B				
A														A				
SEE SHEET 1 EC NO: UCP2012-2472 DRWN:NGUYEN CHKD:JBELL APPR:FSMITH 2012/02/03 2012/02/03 2012/02/09 DESCRIPTION REV QUALITY SYMBOLS ▽=0 ▽=0 ▽=0 GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± .010 2 PLACES ± 0.25 ± .014 1 PLACE ± 0.36 ± --- ANGULAR ±1/2° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS DIMENSION STYLE IN/MM DRAWN BY DATE CHECKED BY DATE APPROVED BY DATE MATERIAL NO. SIZE SCALE 4:1 DESIGN UNITS INCH THIRD ANGLE PROJECTION TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED SDA-43202 SHEET NO. 5 OF 9 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																		
1b_frame_C_P_AM_T Rev. F 2009/06/18	12	11	10	9	8	7	6	5	4			3	2	1				

[illegible]



PC BOARD LAYOUT FOR 4 POSITION HOUSING

(4 CIRCUIT FOOT PRINT SHOWN)
(COMPONENT SIDE OF BOARD)

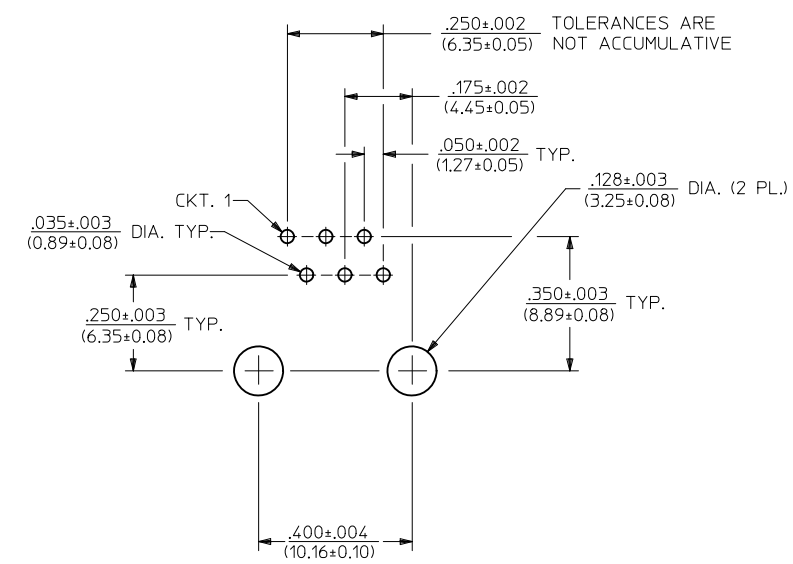


PC BOARD LAYOUT FOR 4 POSITION HOUSING

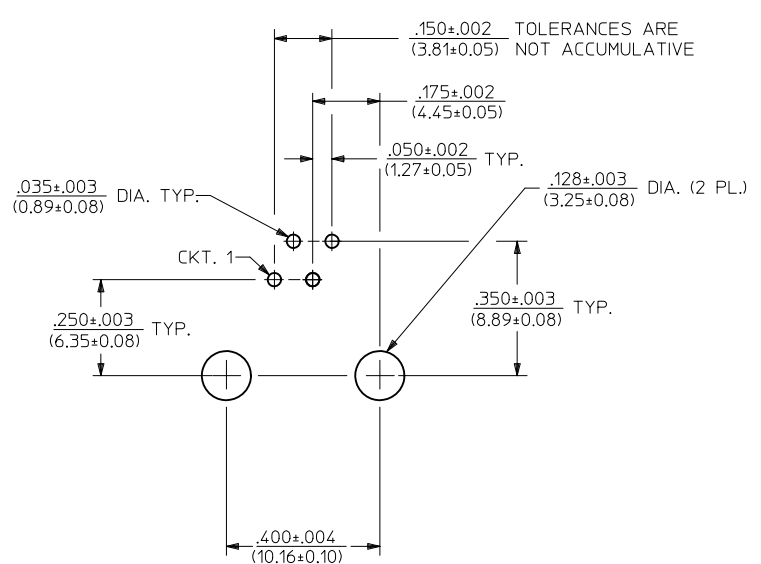
(2 CIRCUIT FOOT PRINT SHOWN)
(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

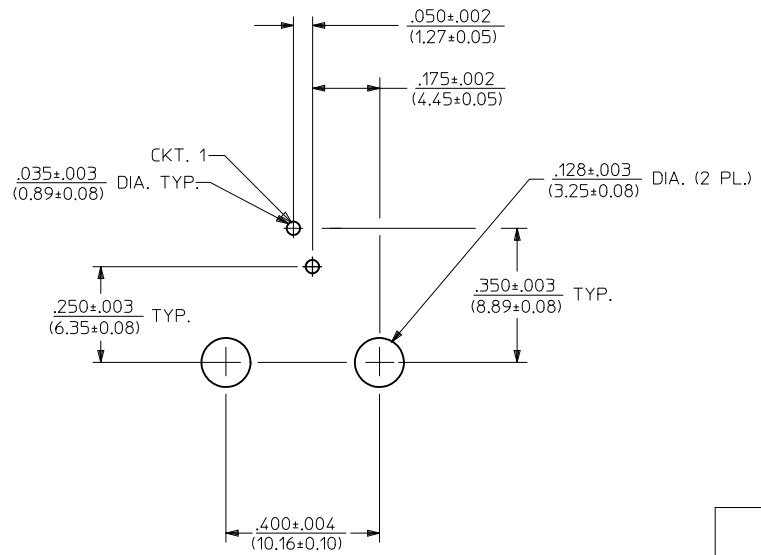
SEE SHEET 1 EC NO: UCP2012-2472 2012/02/03 DRAWN: NGUYEN CHKD: J.BELL 2012/02/03 APPR: F.S.MITH 2012/02/09	REV	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY					
				F=0	4 PLACES	± ---	± ---	DRAWN BY JTR	DATE 1993/03/31	MOLEX MOLEX INCORPORATED							
					3 PLACES	± ---	± .010							CHECKED BY JTR	DATE 1993/03/31		
					2 PLACES	± .025	± .014										
					1 PLACE	± 0.36	± ---										
				ANGULAR ±1/2°			APPROVED BY FSMITH		DATE 2012/02/09				DOCUMENT NO.		SHEET NO. 7 OF 9		
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO. SEE SHEET 6		SDA-43202								
							SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



PC BOARD LAYOUT FOR 6 POSITION HOUSING
(6 CIRCUIT FOOT PRINT SHOWN)
(COMPONENT SIDE OF BOARD)



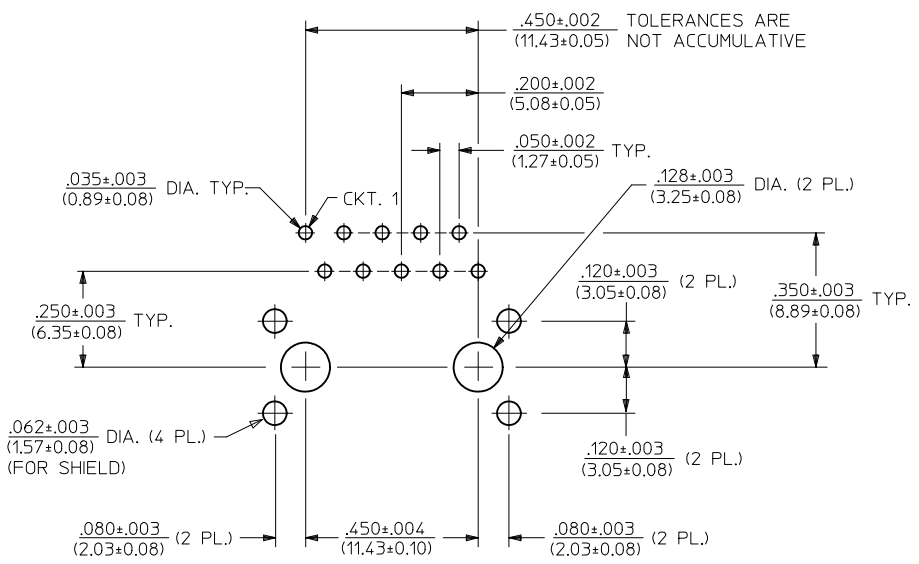
PC BOARD LAYOUT FOR 6 POSITION HOUSING
(4 CIRCUIT FOOT PRINT SHOWN)
(COMPONENT SIDE OF BOARD)



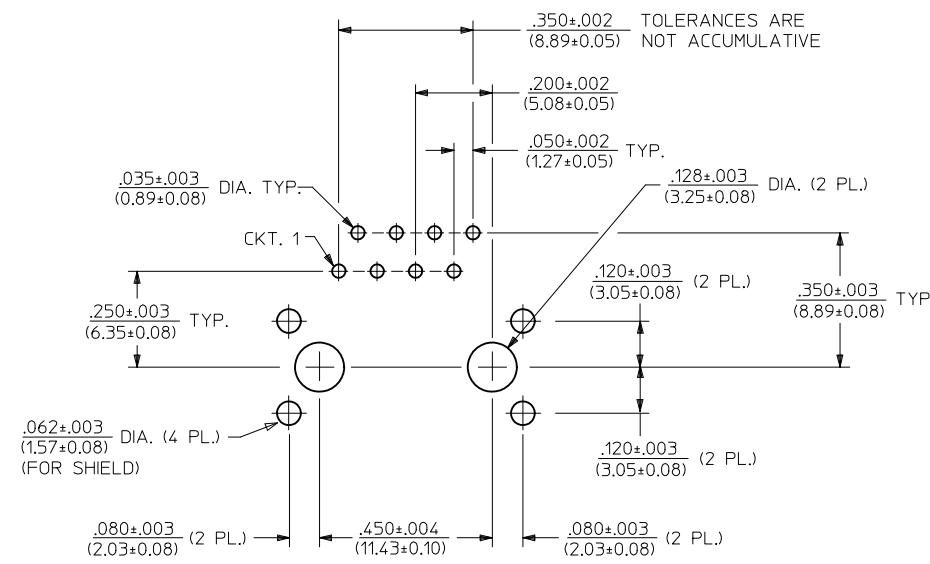
PC BOARD LAYOUT FOR 6 POSITION HOUSING
(2 CIRCUIT FOOT PRINT SHOWN)
(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

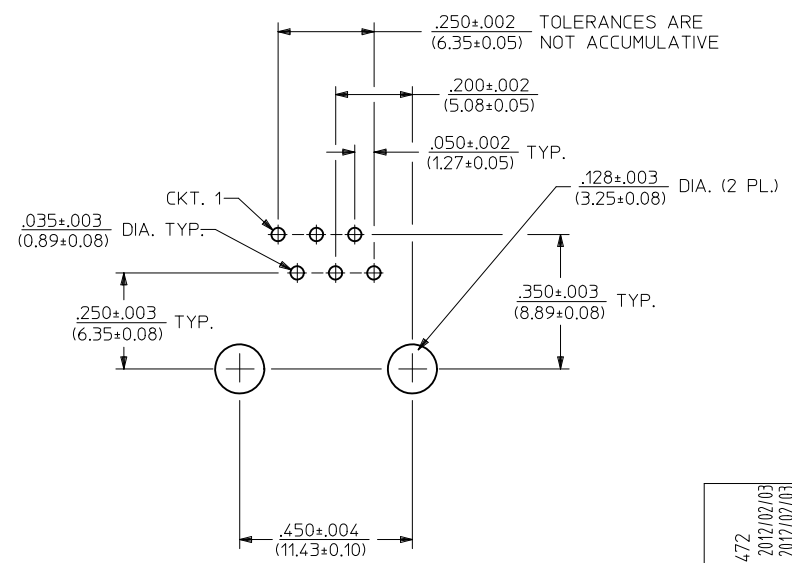
SEE SHEET 1 EC NO: UCP2012-2472 2012/02/03 DRWN:NGUYEN 2012/02/03 CHKD:JBELL 2012/02/09 APPR:FSMITH	DESCRIPTION REV	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX MOLEX INCORPORATED	
				mm	INCH	DRAWN BY DATE		TITLE		
			4 PLACES	± ---	± ---	JTR	1993/03/31			
			3 PLACES	± ---	± .010	CHECKED BY	DATE			
			2 PLACES	± 0.25	± .014	JTR	1993/03/31			
			1 PLACE	± 0.36	± ---	APPROVED BY	DATE			
			ANGULAR ±1/2°		FSMITH	2012/02/09				
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		DOCUMENT NO.			SHEET NO.
					SEE SHEET 6		SDA-43202			8 OF 9
	L5			SIZE C THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



PC BOARD LAYOUT FOR 8 POSITION HOUSING
(10 CIRCUIT FOOTPRINT SHOWN)
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR 8 POSITION HOUSING
(8 CIRCUIT FOOTPRINT SHOWN)
(COMPONENT SIDE OF BOARD)



PC BOARD LAYOUT FOR 8 POSITION HOUSING
(6 CIRCUIT FOOTPRINT SHOWN)
(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

SEE SHEET 1 EC NO: UCP2012-2472 DRAWN: NGUYEN CHKD: J.BELL APPR: F.SMITH REV	DESCRIPTION 2012/02/03 2012/02/03 2012/02/09	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY	
				mm	INCH	DRAWN BY JTR	DATE 1993/03/31	DOCUMENT NO. SDA-43202			
			4 PLACES	± ---	± ---	CHECKED BY JTR	DATE 1993/03/31				
			3 PLACES	± ---	± .010						
			2 PLACES	± 0.25	± .014						
	1 PLACE	± 0.36	± ---	APPROVED BY F.SMITH		DATE 2012/02/09	MOLEX MOLEX INCORPORATED				
			ANGULAR ±1/2°		MATERIAL NO. SEE SHTS 5&6				SHEET NO. 9 OF 9		
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE C		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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